

Hutchip  
 桥芯科技

**HCNS4906**

**40V N-Channel MOSFET**

### General Description

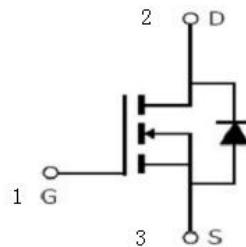
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### Features

$V_{DS}$	40V
$I_D$ (at $V_{GS}=10V$ )	70A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	6.5mΩ(Typ)

**100% UIS TESTED!**  
**100%  $\Delta V_{ds}$  TESTED!**

PDFN5\*6



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$ (TC=25°C)	70	A
	$I_D$ (TC=100°C)	44	A
Maximum Power Dissipation	$P_D$	72	W
Single Pulse Avalanche Energy	EAS	160	mJ
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance junction-case	$R_{\theta JC}$		1.7	°C /W
Thermal Resistance junction-to-Ambient	$R_{\theta JA}$		62	°C /W

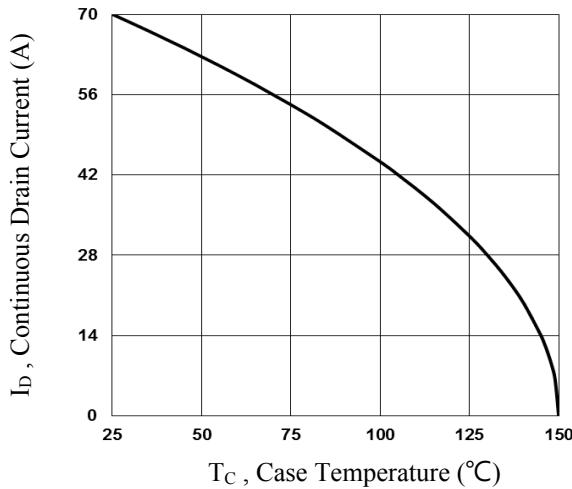
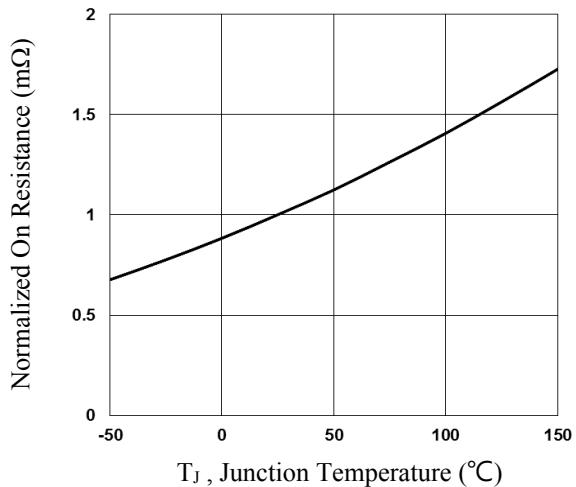
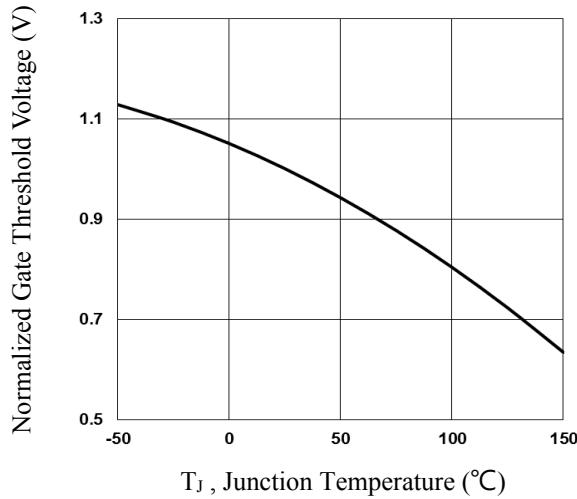
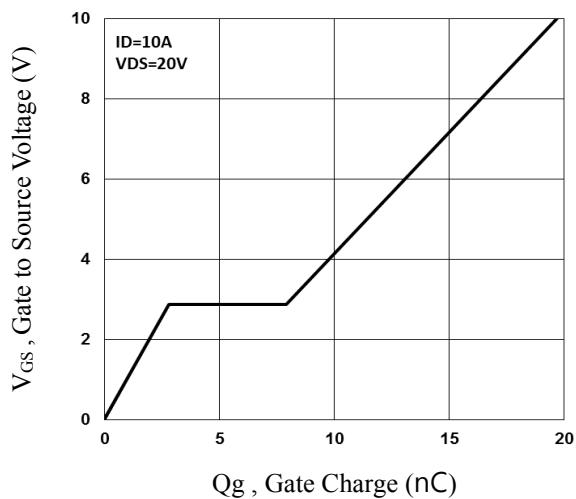
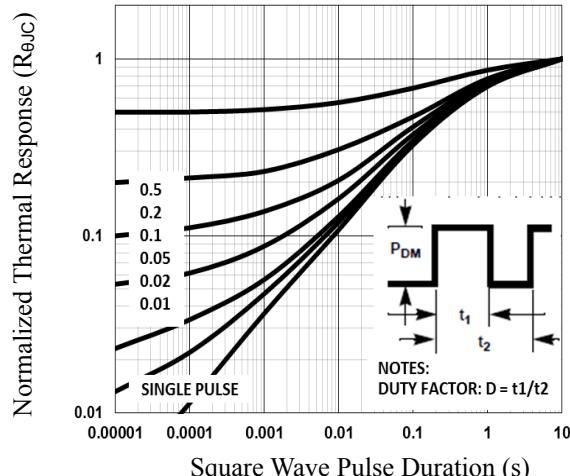
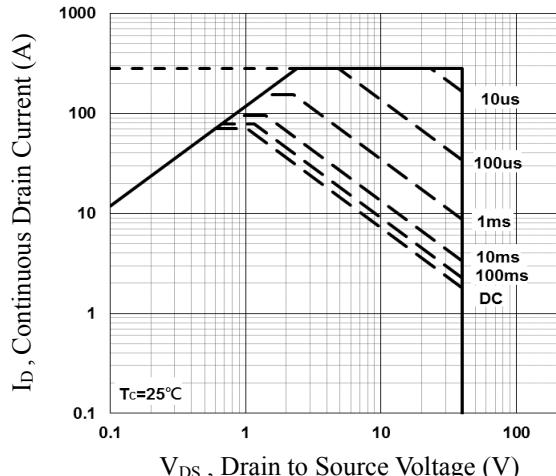
## Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$			1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	2.5	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=15A$		6.5	7.5	$m\Omega$
		$V_{GS}=4.5V, I_D=8A$		9	11	$m\Omega$
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, F=1.0MHz$		1200		pF
$C_{oss}$	Output Capacitance			130		pF
$C_{rss}$	Reverse Transfer Capacitance			87		pF
<b>SWITCHING PARAMETERS</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=15V, I_D=1A, V_{GS}=10V, R_G=3.3\Omega$		13.2		nS
$t_r$	Turn-on Rise Time			2.2		nS
$t_{d(off)}$	Turn-Off Delay Time			72		nS
$t_f$	Turn-Off Fall Time			4.5		nS
$Q_g$	Total Gate Charge	$V_{DS}=20V, I_D=8A, V_{GS}=4.5V$		12.2		nC
$Q_{gs}$	Gate-Source Charge			3.3		nC
$Q_{gd}$	Gate-Drain Charge			6.7		nC
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=1A$		0.72	1.3	V
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		2.2		$\Omega$

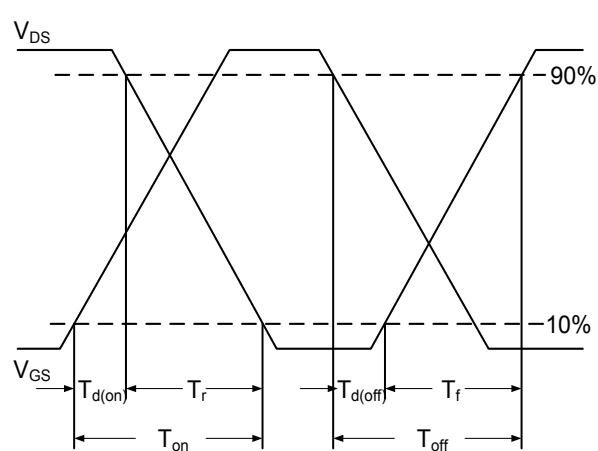
Note:

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.

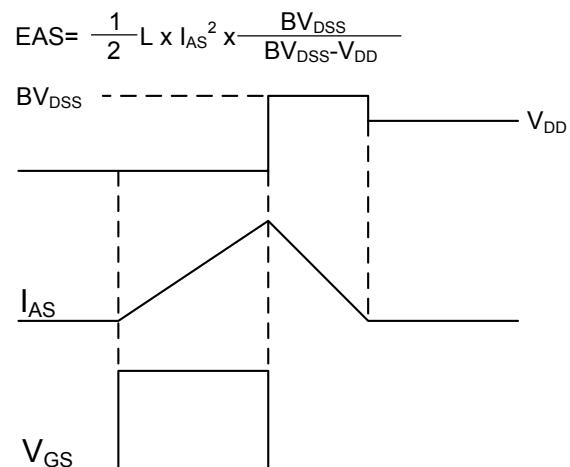
## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

**Fig.1 Continuous Drain Current vs.  $T_c$** **Fig.2 Normalized RDSON vs.  $T_j$** **Fig.3 Normalized  $V_{th}$  vs.  $T_j$** **Fig.4 Gate Charge Waveform****Fig.5 Normalized Transient Impedance****Fig.6 Maximum Safe Operation Area**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

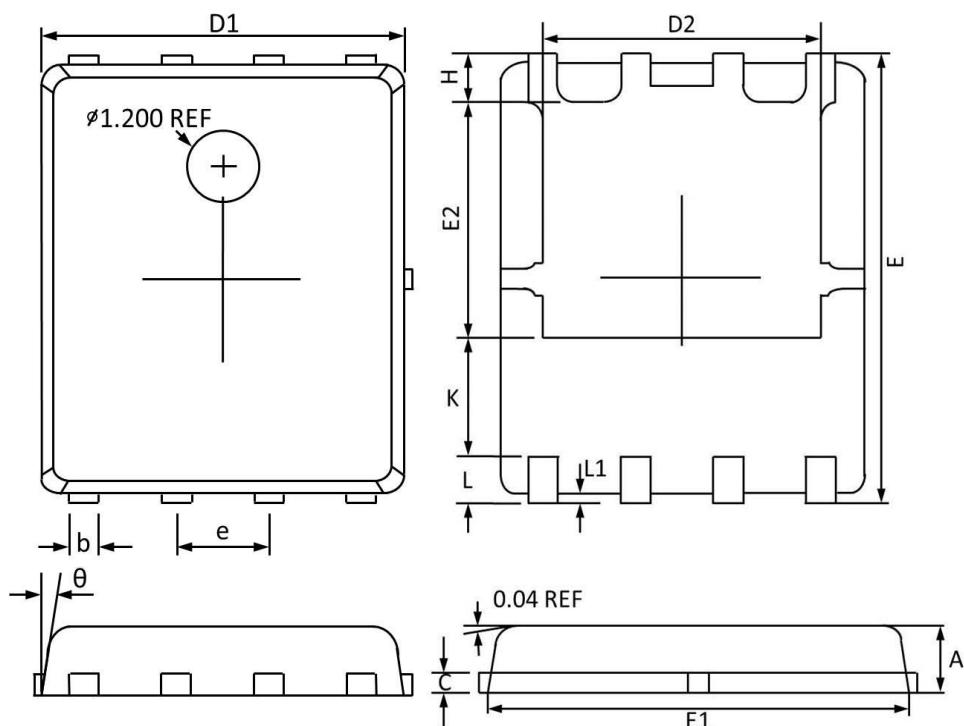


**Fig.7 Switching Time Waveform**



**Fig.8 EAS Waveform**

## PDFN5X6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.100	0.800	0.043	0.031
b	0.510	0.330	0.020	0.013
C	0.300	0.200	0.012	0.008
D1	5.100	4.800	0.201	0.189
D2	4.100	3.610	0.161	0.142
E	6.200	5.900	0.244	0.232
E1	5.900	5.700	0.232	0.224
E2	3.780	3.350	0.149	0.132
e	1.27BSC		0.05BSC	
H	0.700	0.410	0.028	0.016
K	1.500	1.100	0.059	0.043
L	0.710	0.510	0.028	0.020
L1	0.200	0.060	0.008	0.002
$\theta$	12°	0°	12°	0°